DATASHEET - XV-152-D6-57TVRC-10

Touch panel, 24 V DC, 5.7z, TFTcolor, ethernet, RS232, RS485, CAN, PLC



Part no.
EL Number (Norway)

XV-152-D6-57TVRC-10 150529 4521144

Draduct name	Enter VI 152 Touch page
Product name Part no.	Eaton XV-152 Touch panel XV-152-D6-57TVRC-10
EAN	7640130097216
Product Length/Depth	212 millimetre
Product height	52.5 millimetre
Product width	156 millimetre
Product weight	1.3 kilogram
Certifications	EN 50178 IEC/EN 61131-2 IEC/EN 60950 IEC/EN 60079-0 (ATEX 94/9/EG: Zone 22, Category 3D (II 3D Ex tc IIIC T70°C IP6x) CULus UL 508 UL File No.: E205091 IEC/EN 61131-2, CE IEC/EN 61000-6-3 CSA File No.: UL report applies to both US and Canada UL 60950 UL508 DNV GL IEC/EN 61000-6-2 CUL508 IEC/EN 61000-6-2 CUL508 IEC/EN 61241-0 (ATEX 94/9/EG: Zone 22, Category 3D (II 3D Ex tc IIIC T70°C IP6x) IEC/EN 61241-1 (ATEX 94/9/EG: Zone 22, Category 3D (II 3D Ex tc IIIC T70°C IP6x) UL Category Control No.: NRAQ EN 60950 IEC/EN 61000-6-4 Security: UL ATEX 94/9/EG: Zone 22, Category 3D (II 3D Ex tc IIIC T70°C IP6x) Certified by UL for use in Canada CSA Class No.: none EAC
Product Tradename	XV-152
Product Type	Touch panel
Product Sub Type	None
Catalog Notes	4-wire Technology 7 W for basic device + 2.5 W for USB module Heat dissipation with power consumption for 24 V License certificates for onboard interfaces not required Optionally with SD card -> article no. 139807 PLC license inclusive
Enclosure material	Metal, anodized
Features	Fanless CPU and system cooling, natural convection-based passive cooling USB device UL508, cUL approvals USB Host Portrait format Slot for SD card Ethernet interface
Fitted with:	1 x RS232 (built-in interface) 1 x Ethernet 10/100 Mbps (built-in interfaces) Message indication 1 x RS485 (built-in interface) Recipes 1 x USB host 2.0 (built-in interface) SW interfaces 1 x CANopen®/easyNet (built-in interfaces) Numeric keyboard Color display Alpha numeric keyboard Message system (incl. buffer and confirmation) Printer output 1 x USB device (built-in interface)
Functions	Process default value (input) possible Additional software components, loadable Process value representation (output) possible

Battery runtime	Back-up of real-time clock: CR 2032 (190 mA/h), zero maintenance (soldered)
Current consumption	0.4 A, continuous current, Power Supply, 24 V DC
Degree of protection	IP20, rear NEMA 4X IP20
Degree of protection (front side)	IP65 NEMA 4X
Fuse type	Built-in fuse (not accessible)
Lifespan	40,000 h (Service life of back-lighting)
Model	Metal enclosure and front plate
Mounting method	Flush mounting - Clearance: Width x Height x Depth \geq 30 mm (1.18") Flush mounting - Inclination from vertical: $\pm45^{\circ}$ (if using natural convection) Flush mounting
Product category	HMI-PLC (integrated SPS function)
RoHs conformity	Yes
Software Voltage type	XSOFT-CODESYS-2, Visualisation software, Engineering GALILEO, Visualisation software, Engineering XSOFT-CODESYS-3, Visualisation software, Engineering XSOFT-CODESYS-2, PLC-Programming software, Engineering EPAM, Visualisation software, Engineering XSOFT-CODESYS-3, PLC-Programming software, Engineering DC
voltage type	
Shock resistance	Mechanical, According to IEC/EN 60068-2-27
Vibration resistance	According to IEC/EN 60068-2-6
Air pressure	795 - 1080 hPa (operation)
Ambient operating temperature - min	0°C
Ambient operating temperature - max	50 °C
Ambient storage temperature - min	-20 °C
Ambient storage temperature - max	60 °C
Operating temperature - min	0°C
Operating temperature - max	50 °C
Relative humidity	IEC/EN 50178 10 - 95 % (non-condensing)
Voltage dips	5 ms from undervoltage (19.2 V DC)
vorage uips	≤ 10 ms from rated voltage (24 V DC)
Inrush current	12.5 A (for 6 ms)
Permissible voltage	 18 - 31.2 V DC, battery powered (rated operating voltage -25 %/+30 %) 35 V DC (for a duration of < 100 ms) 19.2 - 30 V DC, effective (rated operating voltage -20 %/+25 %) 18.0 - 31.2 V DC, absolute with ripple
Power consumption	2.5 W (USB Slave to USB Host) Max. 7 W 9.5 W total
Rated control supply voltage	24 V DC (UAUX, -20 %/+25 %) 24 V DC (UPOW, -20 %/+25 %)
Rated operational voltage	24 V DC (power-supply - safety extra low voltage)
Supply voltage at AC, 50 Hz - min	0 V AC
Supply voltage at AC, 50 Hz - max	0 V AC
Supply voltage at DC - min	20.4 V DC
Supply voltage at DC - max	28.8 V DC
Interfaces	Ethernet (100Base-TX/10Base-T) USB 2.0 device (not galvanically isolated)
Number of slots	1 (for SD-Card)
Protocol	EtherNet/IP TCP/IP CAN MODBUS Other bus systems

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10.9.2 Power-frequency electric strengthImage: Strength in the panel builder's responsibility.10.9.3 Impulse withstand voltageImage: Strength in the panel builder's responsibility.10.9.4 Testing of enclosures made of insulating materialImage: Strength in the panel builder's responsibility.10.10 Temperature riseImage: Strength in the panel builder's responsibility.10.11 Short-circuit ratingImage: Strength in the panel builder's responsibility.	10.7 Internal electrical circuits and connections	Is the panel builder's responsibility.
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10.11 Short-circuit rating Image: Constraint of the devices of the	10.9.4 Testing of enclosures made of insulating material	Is the panel builder's responsibility.
· · · · · · · · · · · · · · · · · · ·	10.10 Temperature rise	
	10.11 Short-circuit rating	Is the panel builder's responsibility.
10.12 Electromagnetic compatibility Is the panel builder's responsibility.	10.10 Flastromespetie competibility	Is the panel builder's responsibility.

The device meets the requirements, provided the information in the instruction leaflet (IL) is observed.

Technical data ETIM 8.0

Electric engineering, automation, process control engineering / Display and control			
Supply voltage AC 50 Hz	Ň	V	0 - 0
Supply voltage AC 60 Hz	N N	V	0 - 0
Supply voltage DC	N N	V	20.4 - 28.8
Voltage type of supply voltage			DC
Number of HW-interfaces industrial Ethernet			1
Number of interfaces PROFINET			0
Number of HW-interfaces RS-232			1
Number of HW-interfaces RS-422			0
Number of HW-interfaces RS-485			1
Number of HW-interfaces serial TTY			0
Number of HW-interfaces USB			2
Number of HW-interfaces parallel			0
Number of HW-interfaces Wireless			0
Number of HW-interfaces other			1
With SW interfaces			Yes
Supporting protocol for TCP/IP			Yes
Supporting protocol for PROFIBUS			No
Supporting protocol for CAN			Yes
Supporting protocol for INTERBUS			No
Supporting protocol for ASI			No
Supporting protocol for KNX			No
Supporting protocol for Modbus			Yes
Supporting protocol for Data-Highway			No
Supporting protocol for DeviceNet			No
Supporting protocol for SUCONET			No
Supporting protocol for LON			No
Supporting protocol for PROFINET IO			No
Supporting protocol for PROFINET CBA			No
Supporting protocol for SERCOS			No
Supporting protocol for Foundation Fieldbus			No
Supporting protocol for EtherNet/IP			Yes
Supporting protocol for AS-Interface Safety at Work			No
Supporting protocol for DeviceNet Safety			No
Supporting protocol for INTERBUS-Safety			No
Supporting protocol for PROFIsafe			No
Supporting protocol for SafetyBUS p			No
Supporting protocol for other bus systems			Yes
Radio standard Bluetooth			No
Radio standard Wi-Fi 802.11			No
Radio standard GPRS			No
Radio standard GSM			No
Radio standard UMTS			No
IO link master			No
Type of display			TFT
			Yes
With colour display			
Number of colours of the display			65,536
Number of grey-scales/blue-scales of display		inat	0
Screen diagonal	i	inch	5.7
Number of pixels, horizontal			640
Number of pixels, vertical			480

Useful project memory/user memory	kByte	64,000
With numeric keyboard		Yes
With alpha numeric keyboard		Yes
Number of function buttons, programmable		0
Number of buttons with LED		0
Number of system buttons		1
Touch technology		Resistive touch
With message indication		Yes
With message system (incl. buffer and confirmation)		Yes
Process value representation (output) possible		Yes
Process default value (input) possible		Yes
With recipes		Yes
Number of password levels		200
With printer output		Yes
Number of online languages		100
Additional software components, loadable		Yes
Degree of protection (IP), front side		IP65
Degree of protection (NEMA), front side		4X
Operating temperature	°C	0 - 50
Rail mounting possible		No
Wall mounting/direct mounting		No
Suitable for safety functions		No
Width of the front	mm	212
Height of the front	mm	156
Built-in depth	mm	47